



FCB11N60 600V N-Channel MOSFET

Features

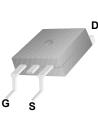
- 650V @T_J = 150°C
- Typ. R_{DS(on)} = 0.32Ω
- Ultra low gate charge (typ. Q_g = 40nC)
- Low effective output capacitance (typ. Coss.eff = 95pF)
- 100% avalanche tested
- RoHS Compliant

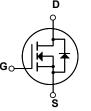


Description

SuperFETTM is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.





Absolute Maximum Ratings

Symbol	Parameter			FCB11N60	Unit	
V _{DSS}	Drain-Source Voltage			600	V	
Ι _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		11 7	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	33	A	
V _{GSS}	Gate-Source voltage			± 30	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	340	mJ	
I _{AR}	Avalanche Current		(Note 1)	11	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	12.5	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns	
P _D	Power Dissipation $(T_C = 25^{\circ}C)$ - Derate above $25^{\circ}C$			125 1.0	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCB11N60	Unit		
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.0	°C/W		
R _{θJA} *	Thermal Resistance, Junction-to-Ambient*	40	°C/W		
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	°C/W		
R _{0JA} Thermal Resistance, Junction-to-Ambient 62.5 °C/W * When mounted on the minimum pad size recommended (PCB Mount) 62.5 °C/W					

Device Marking Device		Device	Pac	kage Reel Size T		Тар	ape Width		Quantity	
FCB11N	_		D ² -	PAK	AK 330mm		24m		800	
Electrica	al Char	racteristics T _c	= 25°C unles	s otherwise no	ted					
Symbol		Parameter			Conditions		Min	Тур	Max	Units
Off Characte	eristics								•	
BV _{DSS}	Drain-Source Breakdown Voltage		V_{GS} = 0V, I _D = 250µA, T _J = 25°C		600			V		
			V_{GS} = 0V, I _D = 250µA, T _J = 150°C			650		V		
000	Breakdown Voltage Temperature Coefficient		e	I_D = 250µA, Referenced to 25°C			0.6		V/°C	
03	Drain-Source Avalanche Breakdown Voltage		down	V _{GS} = 0V, I _D = 11A				700		V
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$					1 10	μΑ μΑ
I _{GSSF}	Gate-Bod	e-Body Leakage Current, Forward		V _{GS} = 30V, V _{DS} = 0V				100	nA	
	Gate-Bod	dy Leakage Current, Reverse		$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Characte	eristics								•	
V _{GS(th)}	Gate Threshold Voltage			$V_{DS} = V_{GS}$	₃ , I _D = 250μA		3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} = 10V, I _D = 5.5A			0.32	0.38	Ω		
9 _{FS}	Forward 1	Transconductance		V _{DS} = 40V	′, I _D = 5.5A	(Note 4)		9.7		S
Dynamic Ch	naracteris	tics							•	
C _{iss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance		$V_{\rm DS}$ = 25V, $V_{\rm GS}$ = 0V,			1148	1490	pF		
C _{oss}			f = 1.0MHz				671	870	pF	
C _{rss}							63		pF	
C _{oss}	Output Capacitance		V _{DS} = 480	V _{DS} = 480V, V _{GS} = 0V, f = 1.0MHz			35		pF	
C _{oss} eff.	Effective Output Capacitance		V_{DS} = 0V to 400V, V_{GS} = 0V			95		pF		
Switching C	haracteri	stics								-
t _{d(on)}	Turn-On Delay Time		$V_{DD} = 300V, I_D = 11A$			34	80	ns		
t _r	Turn-On F	Rise Time		R _G = 25Ω			98	205	ns	
t _{d(off)}	Turn-Off E	Delay Time					119	250	ns	
t _f	Turn-Off F	all Time				(Note 4, 5)		56	120	ns
9	Total Gate	e Charge		V _{DS} = 480V, I _D = 11A V _{GS} = 10V			40	52	nC	
90	Gate-Sou	rce Charge					7.2		nC	
Q _{gd}	Gate-Drai	n Charge				(Note 4, 5)		21		nC
		Characteristics and M							1	1
I _S	Maximum Continuous Drain-Source Diod						11	Α		
I _{SM}	Maximum Pulsed Drain-Source Diode Fo		prward Current				33	Α		
00		rce Diode Forward Vo	oltage	V_{GS} = 0V,	-				1.4	V
		Recovery Time		$V_{GS} = 0V,$				390		ns
Q _{rr}	Reverse F	Recovery Charge		$dI_{F}/dt = 100A/\mu s $ (Note 4)			5.7		μC	

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

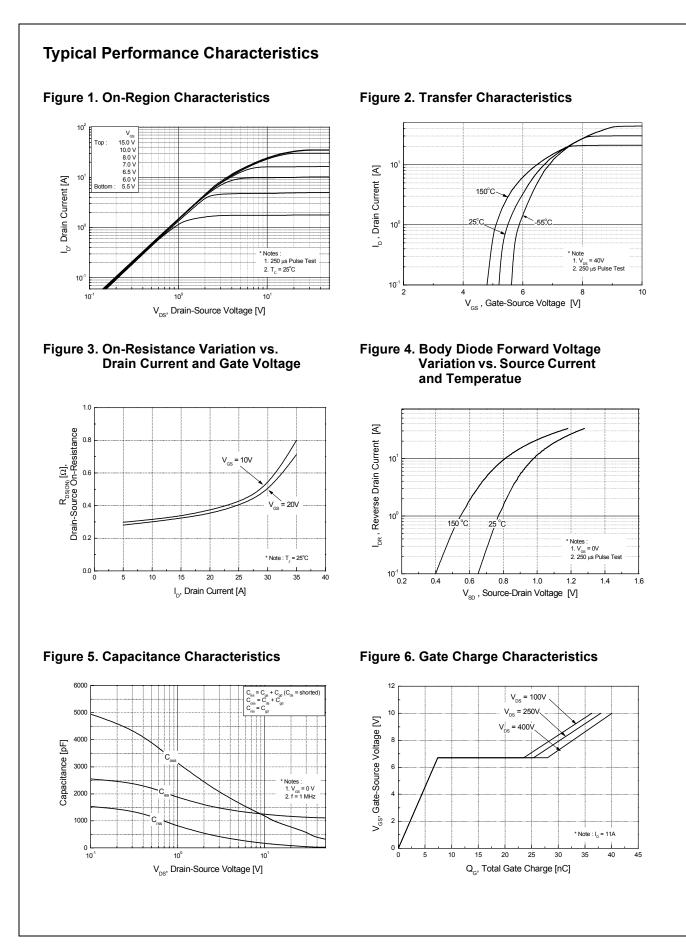
2. I_{AS} = 5.51A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

3. I_{SD} \leq 11A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

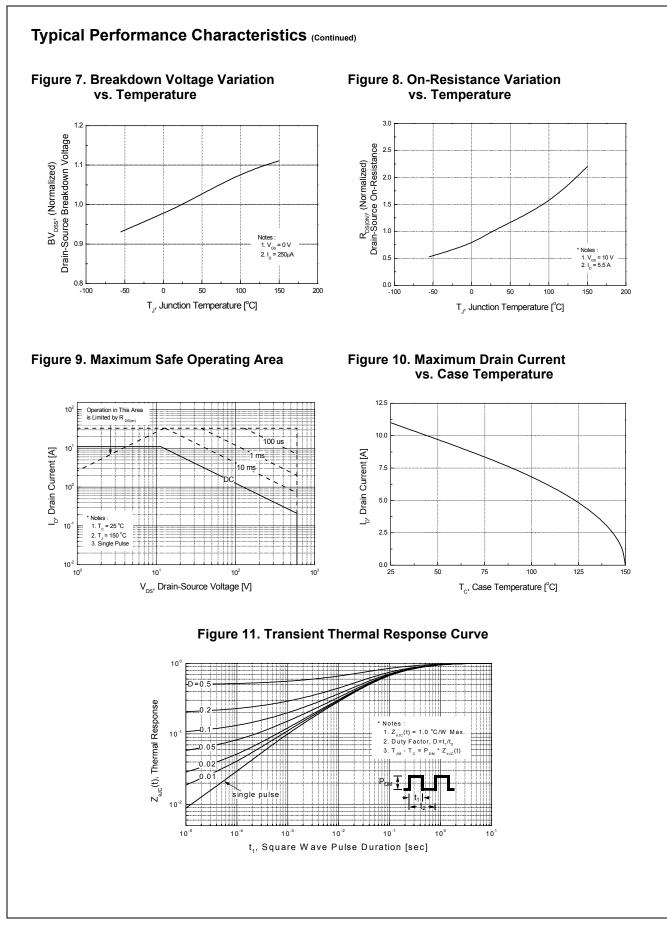
4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics

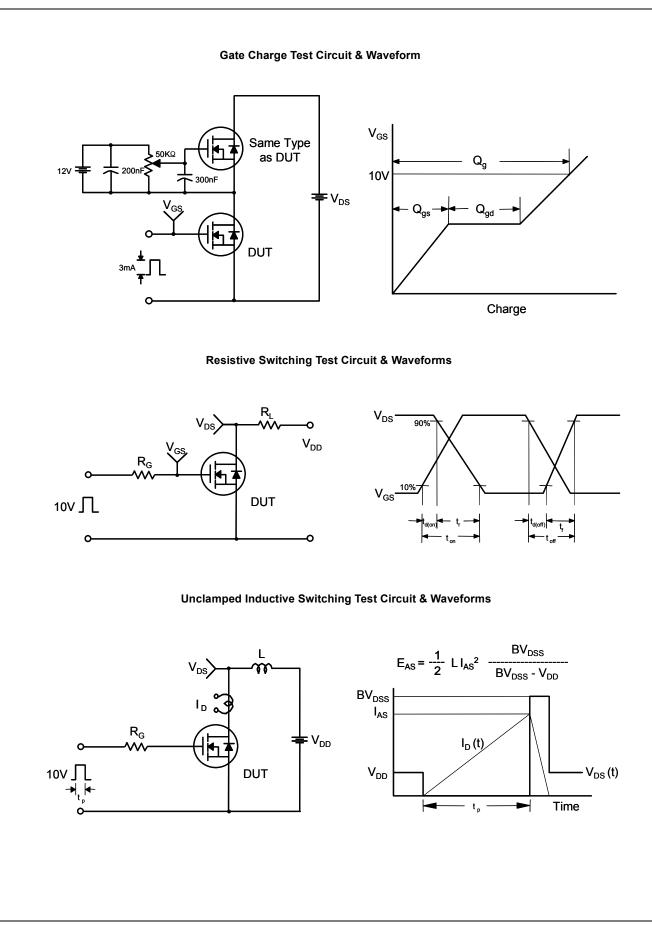
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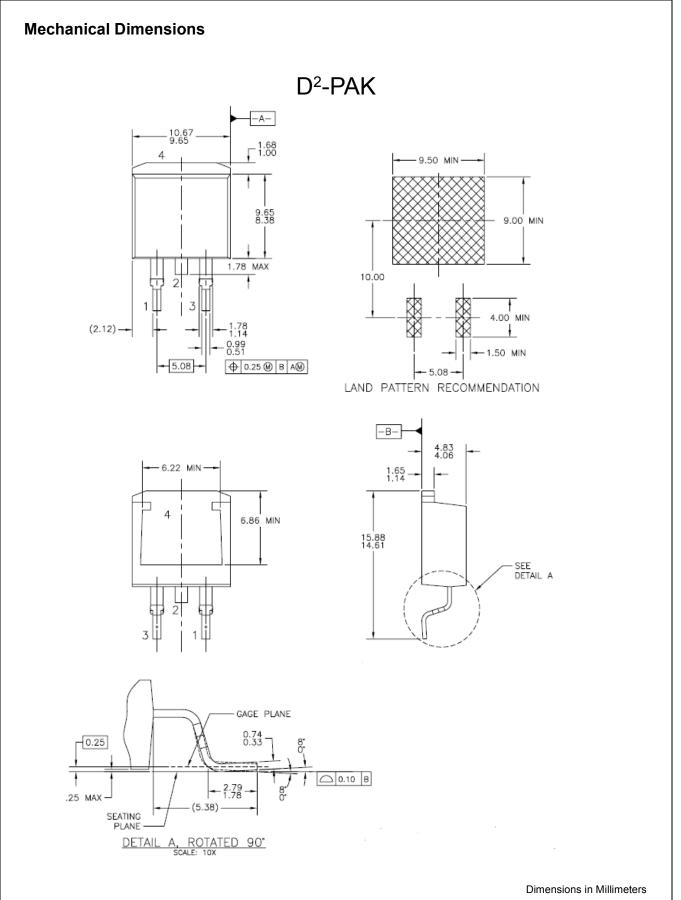


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Peak Diode Recovery dv/dt Test Circuit & Waveforms DUT 0 I SD o L Driver R_G Same Type as DUT $\mathsf{V}_{\mathsf{D}\mathsf{D}}$ ∏∏ v_{gs} - dv/dt controlled by R_{G} - \mathbf{I}_{SD} controlled by pulse period Î Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) \mathbf{I}_{FM} , Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop





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No Identification Needed Full Production Datasheet contains fin make changes at any		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.			
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	•	Rev.			

FCB11N60 Rev. A3

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8